

Electronic Patent Application Fee Transmittal

Application Number:	10678062			
Filing Date:	06-Oct-2003			
Title of Invention:	Multilayer wiring board, touch panel and manufacturing method of the same			
First Named Inventor/Applicant Name:	Tomio Hirano			
Filer:	Marvin Jay Spivak/Kommala Keovongphet			
Attorney Docket Number:	243521US6			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 3 months with \$0 paid	1253	1	1050	1050

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				1050